DH182 Hall-Effect sensor is a temperature stable, stress-resistant latch. Superior high-temperature performance is made possible through a dynamic offset cancellation that utilizes chopper-stabilization. This method reduces the offset voltage normally caused by device over molding, temperature dependencies, and thermal stress.

DH182 includes the following on a single silicon chip: voltage regulator, Hall voltage generator, small-signal amplifier, chopper stabilization, Schmitt trigger, open-drain output. Advanced CMOS wafer fabrication processing is used to take advantage of low-voltage requirements, component matching, very low input-offset errors, and small component geometries.

This device requires the presence of both south and north polarity magnetic fields for operation. In the presence of a south polarity field of sufficient strength, the device output latches on, and only switches off when a north polarity field of sufficient strength is present.

DH182 is rated for operation between the ambient temperatures –40°C and 85°C for the E temperature range, and –40°C to 125°C for the K temperature range. The two package styles available provide magnetically optimized solutions for most applications. Package SO is an SOT-23, a miniature low-profile surface-mount package, while package UA is a three-lead ultra mini SIP for through-hole mounting.

The package type is in a Halogen Free version was verified by third party Lab.

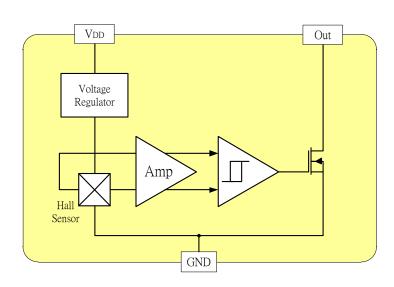
Features and Benefits

- Chopper stabilized amplifier stage
- Optimized for BLDC motor applications
- New miniature package / thin, high reliability package
- Operation down to 3.0V
- 100% tested at 125 °C for K.
- Custom sensitivity / Temperature selection are available.

Applications

- High temperature Fan motor
- 3 phase BLDC motor application
- Speed sensing
- Position sensing
- Current sensing
- Revolution counting
- Solid-State Switch
- Linear Position Detection
- Angular Position Detection
- Proximity Detection

Functional Diagram



电话:0755-84821761 13430722511 网址:http://www.hall-wafer.com

地址:深圳市龙岗区龙西清水路务地埔龙昌10楼1001

Absolute Maximum Ratings At (Ta=25 °C)

Characteristics			Values	Unit	
Supply voltage,(VDD)			26	V	
Output Voltage,(Vout)			26	V	
Reverse voltage, (VDD) (VOUT)			-0.3	V	
Magnetic flux density			Unlimited	Gauss	
Output current , (Iour)			50	mA	
On anoting Town anotyme Banga	(T_{α})	"E" version	-40 to +85	$^{\circ}\! \mathbb{C}$	
Operating Temperature Range, (Temperature Range)		"K" version	-40 to +125	°C	
Storage temperature range, (<i>Ts</i>)			-65 to +150	$^{\circ}\!\mathbb{C}$	
Maximum Junction Temp,(<i>Tj</i>)			150	°C	
Thermal Resistance	(θ_{ja}) UA / SO		206 / 543	°C/W	
	$(heta_{jc})~ ext{UA} / ext{SO}$		148 / 410	°C/W	
Package Power Dissipation, (PD) UA/SO			606 / 230	mW	

型号: DH182

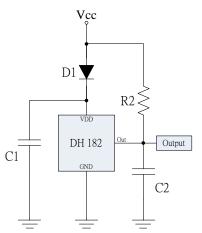
Note: Do not apply reverse voltage to V_{DD} and V_{OUT} Pin, It may be caused for Miss function or damaged device.

Electrical Specifications

DC Operating Parameters : $T_A=+25 \, \text{C}$, $V_{DD}=12V$

Parameters	Test Conditions	Min	Тур	Max	Units
Supply Voltage,(VDD)	Operating	3.0		24.0	V
Supply Current,(<i>I</i> _{DD})	B <b<sub>OP</b<sub>			5.0	mA
Output Saturation Voltage, (Vsat)	IOUT = 10 mA, B>BOP			400.0	mV
Output Leakage Current, (Ioff)	IOFF B <brp, vout="12V</td"><td></td><td></td><td>15.0</td><td>uA</td></brp,>			15.0	uA
Output Rise Time, (TR)	RL=820Ω, CL =20pF			0.45	uS
Output Fall Time, (T_F)	RL=820Ω; CL =20pF			0.45	uS
Operate Point,(BoP)		10		60	Gauss
Release Point,(BRP)		-60		-10	Gauss
Hysteresis,(BHYS)			80		Gauss

Typical application circuit



D1: $1N4148 \text{ or } 100 \Omega$

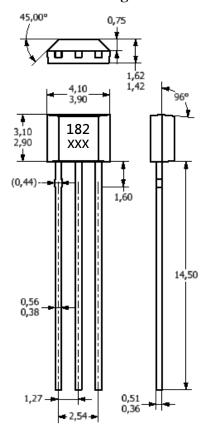
C1: 1000PF C2: 15PF R2: 10K Ω

电话:0755-84821761 13430722511 网址:http://www.hall-wafer.com

地址:深圳市龙岗区龙西清水路务地埔龙昌10楼1001

Sensor Location, Package Dimension and Marking DH182 Package

UA Package



NOTES:

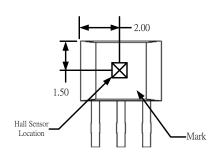
- 1).Controlling dimension: mm
- 2).Leads must be free of flash and plating voids
- Do not bend leads within 1 mm of lead to package interface.
- 4).PINOUT:

Pin 1 VDD

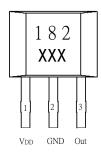
Pin 2 GND

Pin 3 Output

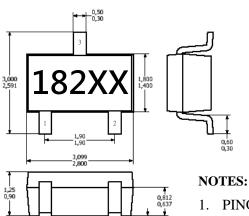
Hall Chip location



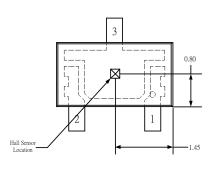
Output Pin Assignment (Top view)



Package (SOT-23) (Top View)



Hall Plate Chip Location (Bottom view)



1. PINOUT (See Top View at left :)

Pin 1 V_{DD}

Pin 2 Output

Pin 3 GND

- 2. Controlling dimension: mm
- Lead thickness after solder plating will be 0.254mm maximum

电话:0755-84821761 13430722511 网址:http://www.hall-wafer.com

地址:深圳市龙岗区龙西清水路务地埔龙昌10楼1001